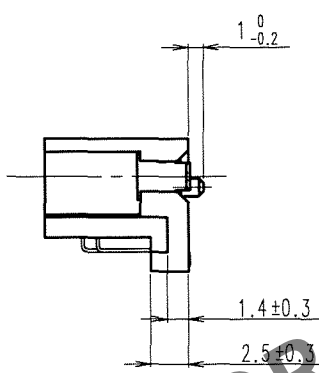
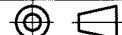


TO



	COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE		COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE
△					. .	△					. .
△					. .	△					. .
△					. .	△					. .

Technical drawing showing a cross-section of a PCB assembly. Dimensions are indicated in parentheses: (8.4) for the total width, (6.6) for the height of the main structure, (0.4) for the width of the bottom layer, and (0.1) for the thickness of the top layer. The bottom layer is labeled PCB. The assembly is mounted on a base with a dimension of 1.1 ± 0.25 .

4	BRASS	TIN-PLATING	2, 3	BRASS	CONTACT AREA : GOLD 0.1μm min.								
1	POLYAMIDE	BEIGE UL94V-0			LEAD AREA : TIN-PLATING 1μm min.								
					UNDER PLATING : NICKEL 1μm min.								
NO.		MATERIAL		FINISH, REMARKS		NO.		MATERIAL		FINISH, REMARKS			
CODE NO. (OLD) CL				DRAWN K.DOI '06.09.30		DESIGNED K. Doi '06.09.30		CHECKED K. Ogawa '06.10.04		APPROVED H. Okawa '06.10.04		RELEASED	
				DRAWING NO. EDC3-151389-21				PART NO. FX5-52P-SH3(71)					
SCALE 2 : 1				 HIROSE ELECTRIC CO., LTD.				CODE NO. CL575-0046-5-71				1/1	
UNITS mm													